

Safety Instructions

Soliphant M

FTM50, FTM51, FTM52

ATEX, IECEx: Ex ta/tb IIIC Da/Db
Ex ta/tb [ia Da] IIIC Da/Db
Ex tb [ia Da] IIIC Db



Soliphant M FTM50, FTM51, FTM52

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About this document



This document has been translated into several languages. Legally determined is solely the English source text.

The document translated into EU languages is available:

- In the download area of the Endress+Hauser website:
www.endress.com -> Downloads -> Manuals and Datasheets -> Type: Ex Safety Instruction (XA) -> Text Search: ...
- In the Device Viewer: www.endress.com -> Product tools -> Access device specific information -> Check device features



If not yet available, the document can be ordered.

Associated documentation

This document is an integral part of the following Operating Instructions:

- KA00229F/00 (FTM50, FTM51)
- KA00230F/00 (FTM52)

Supplementary documentation

Explosion-protection brochure: CP00021Z/11

The Explosion-protection brochure is available:

- In the download area of the Endress+Hauser website:
www.endress.com -> Downloads -> Brochures and Catalogs -> Text Search: CP00021Z
- On the CD for devices with CD-based documentation

Manufacturer's certificates

EU Declaration of Conformity

Declaration Number:
EG05010

The EU Declaration of Conformity is available:
In the download area of the Endress+Hauser website:
www.endress.com -> Downloads -> Declaration -> Type: EU Declaration -> Product Code: ...

EU type-examination certificate

Certificate number:
KEMA 05ATEX2066 X

List of applied standards: See EU Declaration of Conformity.

IEC Declaration of Conformity

Certificate number:
IECEX DEK 15.0036X

Affixing the certificate number certifies conformity with the following standards (depending on the device version):

- IEC 60079-0 : 2017
- IEC 60079-11 : 2011
- IEC 60079-31 : 2013

Other standards

Among other things, the following standards shall be observed in their current version for proper installation:

- IEC/EN 60079-14: "Explosive atmospheres - Part 14: Electrical installations design, selection and erection"
- EN 1127-1: "Explosive atmospheres - Explosion prevention and protection - Part 1: Basic concepts and methodology"

Extended order code

The extended order code is indicated on the nameplate, which is affixed to the device in such a way that it is clearly visible. Additional information about the nameplate is provided in the associated Operating Instructions.

Structure of the extended order code

FTM5x	–	*****	+	A*B*C*D*E*F*G*..
<i>(Device type)</i>		<i>(Basic specifications)</i>		<i>(Optional specifications)</i>

* = Placeholder

At this position, an option (number or letter) selected from the specification is displayed instead of the placeholders.

Basic specifications

The features that are absolutely essential for the device (mandatory features) are specified in the basic specifications. The number of positions depends on the number of features available. The selected option of a feature can consist of several positions.

Optional specifications

The optional specifications describe additional features for the device (optional features). The number of positions depends on the number of features available. The features have a 2-digit structure to aid

identification (e.g. JA). The first digit (ID) stands for the feature group and consists of a number or a letter (e.g. J = Test, Certificate). The second digit constitutes the value that stands for the feature within the group (e.g. A = 3.1 material (wetted parts), inspection certificate).

More detailed information about the device is provided in the following tables. These tables describe the individual positions and IDs in the extended order code which are relevant to hazardous locations.

Extended order code: Soliphant M

Device type

FTM50, FTM51, FTM52

Basic specifications

Position 1 (Approval)		
Selected option		Description
FTM50	2	ATEX II 1/2 D Ex ta/tb IIIC T160°C...T310°C Da/Db ¹⁾
FTM51		ATEX II 2(1) D Ex tb [ia Da] IIIC T83°C Db ²⁾
	G	IECEX Ex ta/tb IIIC T160°C...T310°C Da/Db ¹⁾ IECEX Ex tb [ia Da] IIIC T83°C Db ²⁾
FTM52	2	ATEX II 1/2 D Ex ta/tb [ia Da] IIIC T83°C Da/Db ATEX II 2(1) D Ex tb [ia Da] IIIC T83°C Db ²⁾
	G	IECEX Ex ta/tb [ia Da] IIIC T83°C Da/Db IECEX Ex tb [ia Da] IIIC T83°C Db ²⁾

1) Depending on Position 11

2) Only in connection with Position 7 = D, E, G, H

Position 6 (Electronics, Output)		
Selected option		Description
FTM5x	1	FEM51; 2-wire 19-253VAC
	2	FEM52; 3-wire PNP 10-55VDC
	4	FEM54; relay DPDT, 19-253VAC/55VDC
	5	FEM55; 8/16mA, 11-35VDC

Position 7 (Type of Probe)		
Selected option		Description
FTM5x	A	Compact
	D, E	Cable > separate enclosure
	G, H	Cable, armoured > separate enclosure

Position 8 (Housing)		
Selected option		Description
FTM5x	H	T13 Alu IP66/68 NEMA Type 4X/6P Encl., separate conn. compartment
	3	F17 Alu IP66/67 NEMA Type 4X Encl.
	5	F13 Alu IP66/68 NEMA Type 4X/6P Encl.
	6	F27 316L IP67/68 NEMA Type 4X/6P Encl.
	7	F15 316L hygiene IP66/67 NEMA Type 4X Encl.

Position 11 (Additional Option 2)		
Selected option		Description
FTM50 FTM51	A	Not selected
	C	EN10204-3.1 material (wetted parts), inspection certificate
	D, E	Temp. separator $\leq 150^{\circ}\text{C}$
	F, H	High temperature $\leq 280^{\circ}\text{C}$
	J, K	High temperature $\leq 230^{\circ}\text{C}$
	Y	Special version: High temperature $\leq 300^{\circ}\text{C}$
FTM52	A	Not selected

Optional specifications

No options specific to hazardous locations are available.

Safety instructions:
General

- The device is intended to be used in explosive atmospheres as defined in the scope of IEC 60079-0 or equivalent national standards. If no potentially explosive atmospheres are present or if additional protective measures have been taken: The device may be operated according to the manufacturer's specifications.
- Staff must meet the following conditions for mounting, electrical installation, commissioning and maintenance of the device:
 - Be suitably qualified for their role and the tasks they perform
 - Be trained in explosion protection
 - Be familiar with national regulations
- Install the device according to the manufacturer's instructions and national regulations.
- Do not operate the device outside the specified electrical, thermal and mechanical parameters.
- Only use the device in media to which the wetted materials have sufficient durability.
- Avoid electrostatic charging:
 - Of plastic surfaces (e.g. enclosure, sensor element, special varnishing, attached additional plates, ..)
 - Of isolated capacities (e.g. isolated metallic plates)
- Refer to the temperature tables for the relationship between the permitted ambient temperature for the sensor and/or transmitter, depending on the range of application and the temperature class.
- Modifications to the device can affect the explosion protection and must be carried out by staff authorized to perform such work by Endress+Hauser.

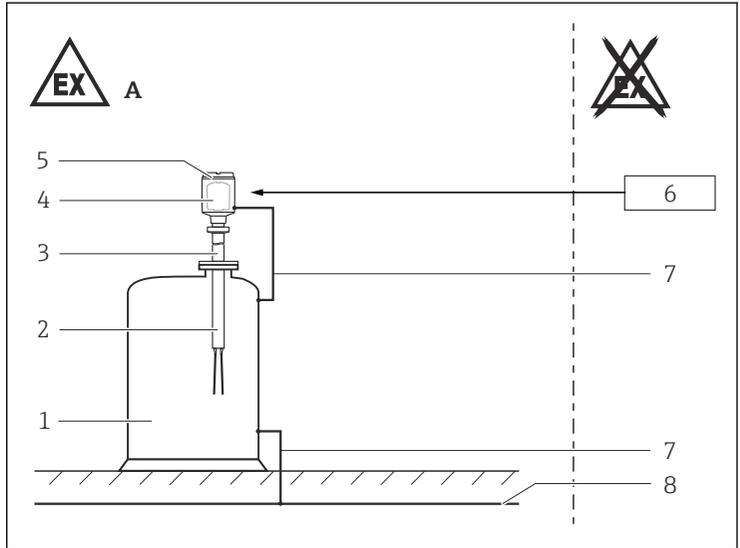
Safety instructions:
Special conditions

- To avoid electrostatic charging: Do not rub surfaces with a dry cloth.
- In the event of additional or alternative special varnishing on the enclosure or other metal parts or for adhesive plates:
 - Observe the danger of electrostatic charging and discharge.
 - Do not install in the vicinity of processes (≤ 0.5 m) generating strong electrostatic charges.

Basic specification, Position 6 = 4

In an explosive atmosphere: Waiting time before opening the electronics compartment after switching off the power supply: 17 minutes.

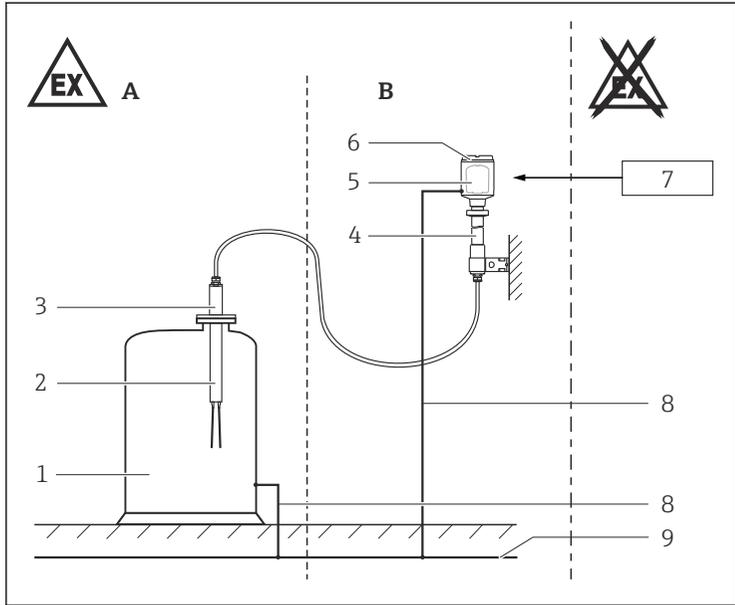
Safety instructions: Installation



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 1

- A Zone 21
- 1 Tank; Hazardous area Zone 20
- 2 Version
- 3 Temperature separator (optional at 150 °C)
- 4 Electronic insert; Electronic compartment Ex tb
- 5 Enclosure
- 6 Power supply
- 7 Potential equalization line
- 8 Potential equalization



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 2

- A Zone 20, Zone 21
 B Zone 21
 1 Tank; Hazardous area Zone 20
 2 Version
 3 Sensor enclosure
 4 Temperature separator (optional at 150 °C)
 5 Electronic insert; Electronic compartment Ex tb
 6 Electronics enclosure
 7 Power supply
 8 Potential equalization line
 9 Potential equalization

- After mounting and connecting the sensor, ingress protection of the enclosure must be at least IP65.
- Perform the following to achieve the degree of protection IP66/67 or IP66/68:
 - Screw the cover tight.
 - Mount the cable entry correctly.
- Use a process connection seal that meets the materials compatibility and temperature requirements.
- When connecting the cables, ensure there is adequate strain relief at place of installation.

- Protect the connecting cable between the separate enclosure and the level sensor from tension and friction (e.g. due to electrostatic charge from medium flow).
- Observe the maximum process conditions according to the manufacturer's Operating Instructions.
- At high medium temperatures, note flange pressure load capacity as a factor of temperature.
- Max. heat-up of device surface in Zone 20 under fault conditions: ≤ 10 K (measured with deposited material with a layer >200 mm in thickness).
- Max. heat-up of device surface in Zone 21 or Zone 22 under fault conditions: ≤ 23 K.
- Install the device to exclude any mechanical damage or friction during the application. Pay particular attention to flow conditions and tank fittings.
- Support extension tube of the device if a dynamic load is expected.
- Only use certified cable entries suitable for the application. Observe national regulations and standards.
- When operating the transmitter enclosure at an ambient temperature under -20 °C, use appropriate cables and cable entries permitted for this application.
- Seal unused entry glands with approved sealing plugs that correspond to the type of protection. The plastic transport sealing plug does not meet this requirement and must therefore be replaced during installation.
- Continuous service temperature of the connecting cable: -50 °C to $\geq +93$ °C; in accordance with the range of service temperature taking into account additional influences of the process conditions ($T_{a,\min}$), ($T_{a,\max} +23$ K).
- Before operation:
 - Screw in the cover all the way.
 - Tighten the securing clamp on the cover.
- In potentially explosive atmospheres:
 - Do not disconnect the electrical connection of the power supply circuit when energized.
 - Do not open the connection compartment cover and the electronics compartment cover when energized.

Accessory high pressure sliding sleeve

The high pressure sliding sleeve can be used for a continuous setting of the switch point and is suited for zone separation if mounted properly (see Operating Instructions).

Potential equalization

Integrate the device into the local potential equalization.

Temperature tables



Basic specification, Position 8 = 3, 7: T_a restriction to -40 °C

Compact version

Basic specification, Position 7 = A

Device type	Basic specification, Position 11	Permissible process temperature T _p FTM50 FTM51	Maximum surface temperature		Permissible ambient temperature T _a Enclosure
			Fork Zone 20	Enclosure Zone 21	
FTM50 FTM51	D, E	-50 to +150 °C	T ₂₀₀ 160 °C	T160 °C	-50 to +60 °C
FTM50 FTM51	F, H	-50 to +280 °C	T ₂₀₀ 290 °C	T290 °C	-50 to +60 °C
FTM50 FTM51	J, K	-50 to +230 °C	T ₂₀₀ 240 °C	T240 °C	-50 to +60 °C
FTM50 FTM51	Y	-50 to +300 °C	T ₂₀₀ 310 °C	T310 °C	-50 to +60 °C
FTM52		-40 to +80 °C	T ₂₀₀ 90 °C	T83 °C	-40 to +60 °C

Version with separate enclosure

Basic specification, Position 7 = D, E, G, H (Sensor)

Device type	Basic specification, Position 11	Permissible process temperature T _p Fork	Maximum surface temperature		Permissible ambient temperature T _a Sensor enclosure
			Fork Zone 20	Sensor enclosure Zone 20/21	
FTM50 FTM51	D, E	-50 to +150 °C	T ₂₀₀ 160 °C	T160 °C	-50 to +80 °C
FTM50 FTM51	F, H	-50 to +280 °C	T ₂₀₀ 290 °C	T290 °C	-50 to +80 °C
FTM50 FTM51	J, K	-50 to +230 °C	T ₂₀₀ 240 °C	T240 °C	-50 to +80 °C
FTM50 FTM51	Y	-50 to +300 °C	T ₂₀₀ 310 °C	T310 °C	-50 to +80 °C
FTM52		-40 to +80 °C	T ₂₀₀ 90 °C	T90 °C	-40 to +80 °C

Basic specification, Position 7 = D, E, G, H (Enclosure)

Device type	Maximum surface temperature	Permissible ambient temperature T_a
	Electronics enclosure Zone 21	Electronics enclosure
FTM50 FTM51 FTM52	T83 °C	-50 to +60 °C

Description notes

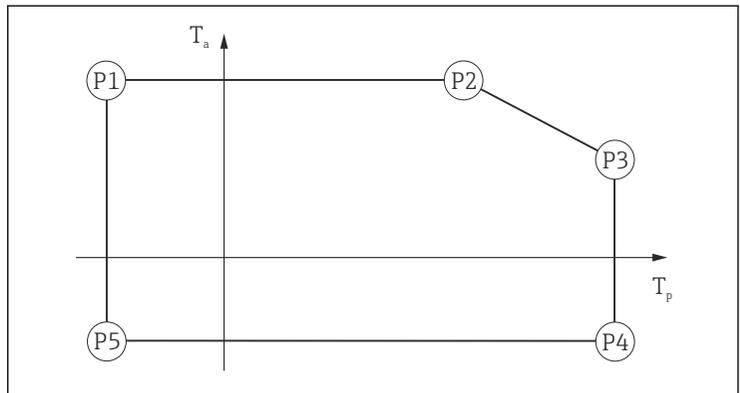
1st column: Device type

2nd column: Position 7 or 11

3rd column: Relay current

Column P1 to P5: Position (temperature value) on the axes of the derating

- T_a : Ambient temperature in °C
- T_p : Process temperature in °C



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*Basic specification, Position 8 = H**with Basic specification, Position 6 = 1*

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A	180 mA	-50	60	60	60	150	40	150	-50	-50	-50
		350 mA	-50	50	60	50	150	30	150	-50	-50	-50
FTM50 FTM51	11 = D, E	180 mA	-50	60	75	60	150	55	150	-50	-50	-50
		350 mA	-50	50	80	50	150	45	150	-50	-50	-50
FTM50 FTM51	11 = J, K	180 mA	-50	60	75	60	230	50	230	-50	-50	-50
		350 mA	-50	50	90	50	230	40	230	-50	-50	-50
FTM50 FTM51	11 = F, H	180 mA	-50	60	85	60	280	50	280	-50	-50	-50
		350 mA	-50	50	105	50	280	40	280	-50	-50	-50
FTM50 FTM51	11 = Y	180 mA	-50	60	85	60	300	50	300	-50	-50	-50
		350 mA	-50	50	105	50	300	40	300	-50	-50	-50
FTM52		180 mA	-40	60	60	60	80	55	80	-40	-40	-40
		350 mA	-40	50	60	50	80	45	80	-40	-40	-40

with Basic specification, Position 6 = 2

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A		-50	60	80	60	150	45	150	-50	-50	-50
FTM50 FTM51	11 = D, E		-50	60	130	60	150	55	150	-50	-50	-50
FTM50 FTM51	11 = J, K		-50	60	145	60	230	55	230	-50	-50	-50
FTM50 FTM51	11 = F, H		-50	60	175	60	280	55	280	-50	-50	-50
FTM50 FTM51	11 = Y		-50	60	175	60	300	55	300	-50	-50	-50
FTM52			-40	60	80	60	80	60	80	-40	-40	-40

with Basic specification, Position 6 = 4

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A	2 A	-50	60	60	60	150	40	150	-50	-50	-50
		4 A	-50	50	60	50	150	30	150	-50	-50	-50
		6 A	-50	40	60	40	60	40	60	-50	-50	-50
FTM50 FTM51	11 = D, E	2 A	-50	60	75	60	150	55	150	-50	-50	-50
		4 A	-50	50	80	50	150	45	150	-50	-50	-50
		6 A	-50	40	110	40	150	35	150	-50	-50	-50
FTM50 FTM51	11 = J, K	2 A	-50	60	75	60	230	50	230	-50	-50	-50
		4 A	-50	50	90	50	230	40	230	-50	-50	-50
		6 A	-50	40	125	40	230	35	230	-50	-50	-50
FTM50 FTM51	11 = F, H	2 A	-50	60	85	60	280	50	280	-50	-50	-50
		4 A	-50	50	105	50	280	40	280	-50	-50	-50
		6 A	-50	40	155	40	280	35	280	-50	-50	-50
FTM50 FTM51	11 = Y	2 A	-50	60	85	60	300	50	300	-50	-50	-50
		4 A	-50	50	105	50	300	40	300	-50	-50	-50
		6 A	-50	40	155	40	300	35	300	-50	-50	-50
FTM52		2 A	-40	60	60	60	80	55	80	-40	-40	-40
		4 A	-40	50	60	50	80	45	80	-40	-40	-40
		6 A	-40	45	65	45	80	35	50	-40	-40	-40

with Basic specification, Position 6 = 5

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A		-50	60	75	60	150	40	150	-50	-50	-50
FTM50 FTM51	11 = D, E		-50	60	110	60	150	55	150	-50	-50	-50
FTM50 FTM51	11 = J, K		-50	60	125	60	230	55	230	-50	-50	-50
FTM50 FTM51	11 = F, H		-50	60	145	60	280	55	280	-50	-50	-50
FTM50 FTM51	11 = Y		-50	60	145	60	300	55	300	-50	-50	-50
FTM52			-40	60	75	60	80	55	80	-40	-40	-40

Basic specification, Position 8 = 3, 5, 6

with Basic specification, Position 6 = 1

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A	180 mA	-50	60	60	60	150	25	150	-50	-50	-50
		350 mA	-50	50	55	50	85	40	85	-50	-50	-50
FTM50 FTM51	11 = D, E	180 mA	-50	60	70	60	150	50	150	-50	-50	-50
		350 mA	-50	50	75	50	150	40	150	-50	-50	-50
FTM50 FTM51	11 = J, K	180 mA	-50	60	75	60	230	50	230	-50	-50	-50
		350 mA	-50	50	85	50	230	40	230	-50	-50	-50
FTM50 FTM51	11 = F, H	180 mA	-50	60	80	60	280	50	280	-50	-50	-50
		350 mA	-50	50	95	50	280	40	280	-50	-50	-50
FTM50 FTM51	11 = Y	180 mA	-50	60	80	60	300	50	300	-50	-50	-50
		350 mA	-50	50	95	50	300	40	300	-50	-50	-50
FTM52		180 mA	-40	60	60	60	80	50	80	-40	-40	-40
		350 mA	-40	50	55	50	80	40	80	-40	-40	-40

with Basic specification, Position 6 = 2

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A		-50	60	70	60	150	30	150	-50	-50	-50
FTM50 FTM51	11 = D, E		-50	60	115	60	150	55	150	-50	-50	-50
FTM50 FTM51	11 = J, K		-50	60	135	60	230	55	230	-50	-50	-50
FTM50 FTM51	11 = F, H		-50	60	155	60	280	50	280	-50	-50	-50
FTM50 FTM51	11 = Y		-50	60	155	60	300	50	300	-50	-50	-50
FTM52			-40	60	70	60	80	55	80	-40	-40	-40

with Basic specification, Position 6 = 4

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A	2 A	-50	50	50	50	75	40	75	-50	-50	-50
		4 A	-50	45	55	45	65	40	65	-50	-50	-50
		6 A	-50	40	50	40	50	40	50	-50	-50	-50
FTM50 FTM51	11 = D, E	2 A	-50	50	60	40	150	40	150	-50	-50	-50
		4 A	-50	45	90	45	150	40	150	-50	-50	-50
		6 A	-50	40	85	40	150	30	150	-50	-50	-50
FTM50 FTM51	11 = J, K	2 A	-50	50	65	50	230	40	230	-50	-50	-50
		4 A	-50	45	110	45	230	35	230	-50	-50	-50
		6 A	-50	40	105	40	230	30	230	-50	-50	-50
FTM50 FTM51	11 = F, H	2 A	-50	50	75	50	280	40	280	-50	-50	-50
		4 A	-50	45	140	45	280	35	280	-50	-50	-50
		6 A	-50	40	135	40	280	30	280	-50	-50	-50
FTM50 FTM51	11 = Y	2 A	-50	50	75	50	300	40	300	-50	-50	-50
		4 A	-50	45	140	45	300	35	300	-50	-50	-50
		6 A	-50	40	135	40	300	30	300	-50	-50	-50
FTM52		2 A	-40	50	50	50	80	35	80	-40	-40	-40
		4 A	-40	45	50	45	80	35	80	-40	-40	-40
		6 A	-40	40	50	40	50	40	50	-40	-40	-40

with Basic specification, Position 6 = 5

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A		-50	60	70	60	150	30	150	-50	-50	-50
FTM50 FTM51	11 = D, E		-50	60	100	60	150	55	150	-50	-50	-50
FTM50 FTM51	11 = J, K		-50	60	115	60	230	50	230	-50	-50	-50
FTM50 FTM51	11 = F, H		-50	60	130	60	280	50	280	-50	-50	-50
FTM50 FTM51	11 = Y		-50	60	130	60	300	50	300	-50	-50	-50
FTM52			-40	60	70	60	80	55	80	-40	-40	-40

*Basic specification, Position 8 = 7**with Basic specification, Position 6 = 1*

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A	180 mA	-50	60	60	60	150	25	150	-50	-50	-50
		350 mA	-50	50	55	50	85	40	85	-50	-50	-50
FTM50 FTM51	11 = D, E	180 mA	-50	60	75	60	150	50	150	-50	-50	-50
		350 mA	-50	50	75	50	150	40	150	-50	-50	-50
FTM50 FTM51	11 = J, K	180 mA	-50	60	75	60	230	50	230	-50	-50	-50
		350 mA	-50	50	85	50	230	40	230	-50	-50	-50
FTM50 FTM51	11 = F, H	180 mA	-50	60	80	60	280	50	280	-50	-50	-50
		350 mA	-50	50	95	50	280	40	280	-50	-50	-50
FTM50 FTM51	11 = Y	180 mA	-50	60	80	60	300	50	300	-50	-50	-50
		350 mA	-50	50	95	50	300	40	300	-50	-50	-50
FTM52		180 mA	-40	60	60	60	80	50	80	-40	-40	-40
		350 mA	-40	50	55	50	80	40	80	-40	-40	-40

with Basic specification, Position 6 = 2

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A		-50	60	70	60	150	30	150	-50	-50	-50
FTM50 FTM51	11 = D, E		-50	60	115	60	150	55	150	-50	-50	-50
FTM50 FTM51	11 = J, K		-50	60	135	60	230	55	230	-50	-50	-50
FTM50 FTM51	11 = F, H		-50	60	155	60	280	50	280	-50	-50	-50
FTM50 FTM51	11 = Y		-50	60	155	60	300	50	300	-50	-50	-50
FTM52			-40	60	70	60	80	55	80	-40	-40	-40

with Basic specification, Position 6 = 4

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A	2 A	-50	45	50	45	100	20	100	-50	-50	-50
		4 A	-50	35	35	35	70	20	70	-50	-50	-50
FTM50 FTM51	11 = D, E	2 A	-50	45	50	45	150	35	150	-50	-50	-50
		4 A	-50	35	35	35	150	25	150	-50	-50	-50
FTM50 FTM51	11 = J, K	2 A	-50	45	50	45	230	35	230	-50	-50	-50
		4 A	-50	35	40	35	230	20	230	-50	-50	-50
FTM50 FTM51	11 = F, H	2 A	-50	45	50	45	280	35	280	-50	-50	-50
		4 A	-50	35	40	35	280	20	280	-50	-50	-50
FTM50 FTM51	11 = Y	2 A	-50	45	50	45	300	35	300	-50	-50	-50
		4 A	-50	35	40	35	300	20	300	-50	-50	-50
FTM52		2 A	-40	45	50	45	80	35	80	-40	-40	-40
		4 A	-40	35	35	35	70	20	70	-40	-40	-40

with Basic specification, Position 6 = 5

			P1		P2		P3		P4		P5	
			T _p	T _a								
FTM50 FTM51	7 = A		-50	60	70	60	150	30	150	-50	-50	-50
FTM50 FTM51	11 = D, E		-50	60	100	60	150	55	150	-50	-50	-50
FTM50 FTM51	11 = J, K		-50	60	115	60	230	50	230	-50	-50	-50
FTM50 FTM51	11 = F, H		-50	60	130	60	280	50	280	-50	-50	-50
FTM50 FTM51	11 = Y		-50	60	130	60	300	50	300	-50	-50	-50
FTM52			-40	60	70	60	80	55	80	-40	-40	-40

Deposited material with a layer of 200 nm

Device type	Surface temperature T_{200}	Ambient temperature T_a (ambient): probe with Basic specification, Position 7 = D, E, G, H
FTM50 FTM51	T 130 °C	max. 80 °C
FTM52		max. 80 °C

Device type	Basic specification, Position	P1		P2		P3		P4		P5	
		T_p	T_a								
FTM50 FTM51	7 = A	-50	40	40	40	40	40	40	-50	-50	-50
FTM50 FTM51	11 = D, E, J, K, F, H, Y	-50	40	40	40	40	40	40	-50	-50	-50
FTM52		-40	40	40	40	40	40	40	-40	-40	-40

Connection data

Basic specification, Position 6	Power supply	Output
1	19 to 253 V_{AC} , 50/60 Hz, max. 1.0 W $U_m = 253 V_{AC}$	max. 350 mA
2	10 to 55 V_{DC} , max. 0.86 W $U_m = 253 V_{AC}$	PNP transistor, max. 350 mA
4	19 to 55 V_{DC} , max. 1.5 W 19 to 253 V_{AC} , 50/60 Hz, max. 1.5 W $U_m = 253 V_{AC}$	2 potential free change-over contacts, 253 V_{AC} , 4 A; 1500 VA / $\cos \varphi = 1$; 750 VA $\cos \varphi > 0.7$ 30 V_{DC} , 4 A; 125 V_{DC} , 0.2 A
5	11 to 35 V_{DC} , 8/16 mA, max. 0.6 W $U_m = 253 V_{AC}$	<3.6 mA / 8 mA / 16 mA



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